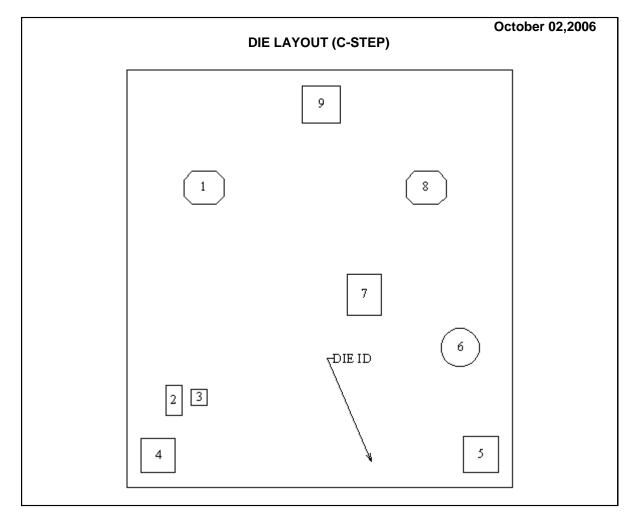


# LM117HVKG MD8 MCD2370A 3-TERMINAL ADJUSTABLE REGULATOR



# DIE/WAFER CHARACTERISTICS

Fabrication Attributes		General D	General Die Information		
Physical Die Identification	117C	Bond Pad Opening Size (min)	229µm x 188µm		
Die Step	С	Bond Pad Metalization	ALUMINUM		
Phys	Physical Attributes		VOM NITRIDE		
Wafer Diameter	100 or 150mm	Back Side Metal	Gold		
Die Size (Drawn)	2362µm x 2184µm 93.0mils x 86.0mils	Back Side Connection	OUTPUT		
Thickness	254µm Nominal				
Min Pitch	146µm Nominal				

# Special Assembly Requirements:

Note: Actual die size is rounded to the nearest micron.



DPBU Die Datasheet

The Sight & Sound of Information

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Die Bond Pad Coordinate Locations (C -Step)								
(Referenced to die center, coordinates in $\mu$ m) NC = No Connection, N.U. = Not Used								
SIGNAL	PAD#	X/Y COORDINATES PAD SIZE			IZE			
NAME	NUMBER	Х	Y	Х		Υ		
OUTPUT	1	-655	516	229	х	188		
NC	2	-827	-690	89	х	170		
NC	3	-681	-673	91	х	91		
OUTPUT	4	-914	-1001	193	х	198		
ADJ	5	913	-997	196	х	206		
NC	6	800	-391	208	Х	208		
INPUT	7	254	-91	193	х	234		
OUTPUT	8	603	514	226	х	185		
INPUT	9	10	987	213	х	211		

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